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\*DD Vishay semiconduttori italiana SPA

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\*This document is intended as a SPICE modeling guideline and does not

\*constitute a commercial product datasheet. Designers should refer to the

\*appropriate datasheet of the same number for guaranteed specification

\*limits.

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Thermal Model Subcircuit

.SUBCKT VS- 30BQ100 5 1

CTHERM1 5 4 1.47E-04

CTHERM2 4 3 6.02E-03

CTHERM3 3 2 9.74E-02

CTHERM4 2 1 1.56E+00

RTHERM1 5 4 7.75E-01

RTHERM2 4 3 2.84E+00

RTHERM3 3 2 4.93E+00

RTHERM4 2 1 3.34E+00

.ENDS VS- 30BQ100

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